Kingbright

AAA3528LSEEZGKQBKS

3.5 x 2.8 mm Surface Mount LED Lamp

DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Blue source color devices are made with InGaN on Sapphire Light Emitting Diode
- Electrostatic discharge and power surge could Damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- Suitable for all SMD assembly and solder process
- Available on tape and reel
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

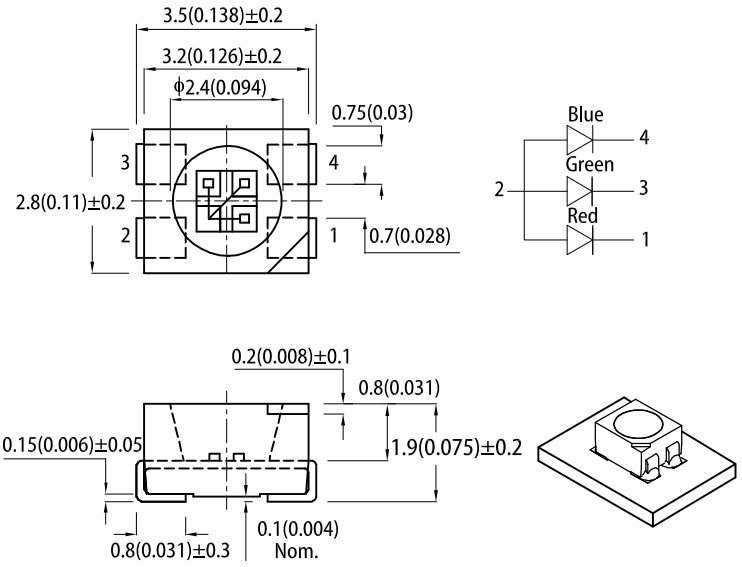
APPLICATIONS

- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

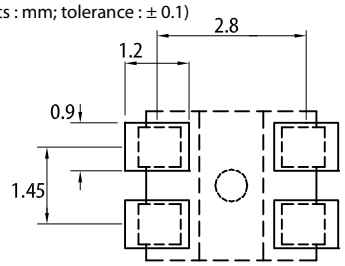
Observe precautions for handling electrostatic discharge sensitive devices

PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 2mA [2]		Viewing Angle [1]
			Min.	Typ.	2θ1/2
AAA3528LSEEZGKQBKS	Hyper Red (AlGaInP)	Water Clear	10	20	120°
	Green (InGaN)		80	180	
	Blue (InGaN)		12	30	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.
3. Luminous intensity value is traceable to CIE127-2007 standards.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission I_F = 2mA	λ_{peak}	Hyper Red Green Blue	630 515 460	-	nm
Dominant Wavelength I_F = 2mA	λ_{dom} [1]	Hyper Red Green Blue	621 525 465	-	nm
Spectral Bandwidth at 50% Φ REL MAX I_F = 2mA	Δλ	Hyper Red Green Blue	20 35 25	-	nm
Capacitance	C	Hyper Red Green Blue	25 45 100	-	pF
Forward Voltage I_F = 2mA	V_F [2]	Hyper Red Green Blue	1.8 2.65 2.65	2.1 3.1 3.1	V
Reverse Current (V_R = 5V)	I_R	Hyper Red Green Blue	-	10 50 50	uA
Temperature Coefficient of λ_{peak} I_F = 2mA, -10°C ≤ T ≤ 85°C	$TC_{\lambda peak}$	Hyper Red Green Blue	0.13 0.05 0.04	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 2mA, -10°C ≤ T ≤ 85°C	$TC_{\lambda dom}$	Hyper Red Green Blue	0.06 0.03 0.03	-	nm/°C
Temperature Coefficient of V_F I_F = 2mA, -10°C ≤ T ≤ 85°C	TC_V	Hyper Red Green Blue	-1.9 -2.9 -2.9	-	mV/°C

Notes:
1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value			Unit
		Hyper Red	Green	Blue	
Power Dissipation	P_D	125	123	120	mW
Reverse Voltage	V_R	5	5	5	V
Junction Temperature	T_j	115	115	115	°C
Operating Temperature	T_{op}	-40 to +85			°C
Storage Temperature	T_{stg}	-40 to +85			°C
DC Forward Current	I_F	50	30	30	mA
Peak Forward Current	I_{FM} [1]	195	150	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	250	V
Thermal Resistance (Junction / Ambient)	$R_{th\ JA}$ [2]	340	320	350	°C/W
Thermal Resistance (Junction / Solder point)	$R_{th\ JS}$ [2]	190	190	240	°C/W

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{th\ JA}$,$R_{th\ JS}$ Results from mounting on PC board FR4 (pad size ≥ 16 mm^2 per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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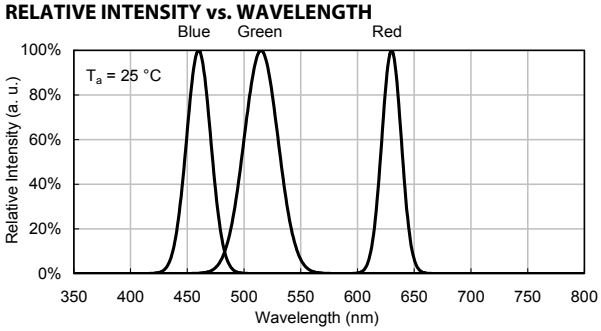
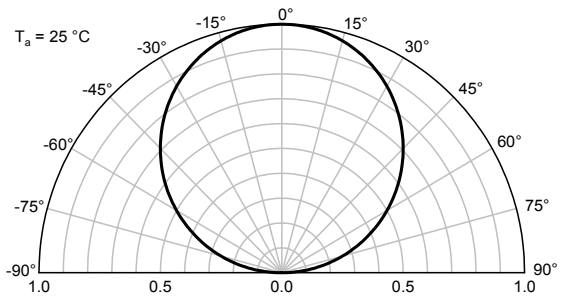
TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

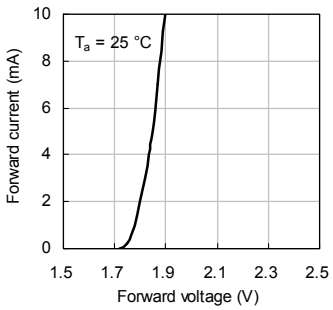


SPATIAL DISTRIBUTION

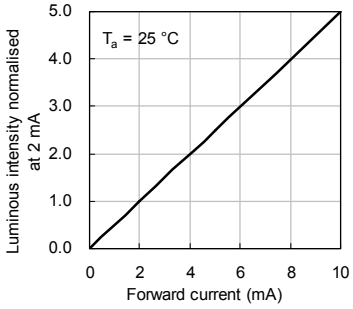


HYPER RED

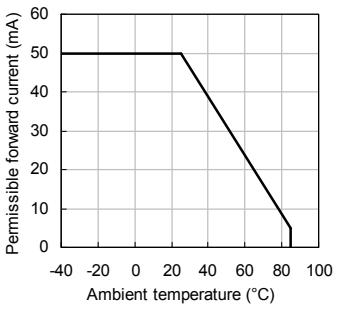
Forward Current vs. Forward Voltage



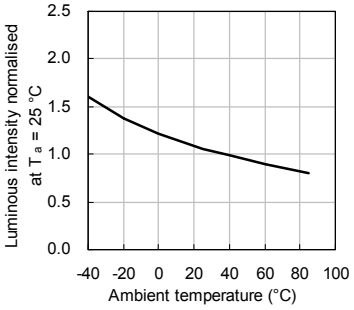
Luminous Intensity vs. Forward Current



Forward Current Derating Curve

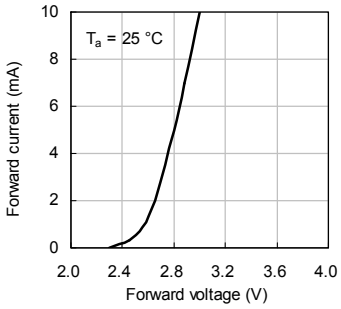


Luminous Intensity vs. Ambient Temperature

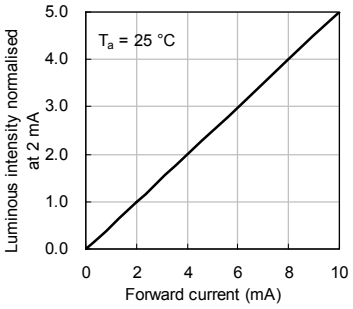


GREEN

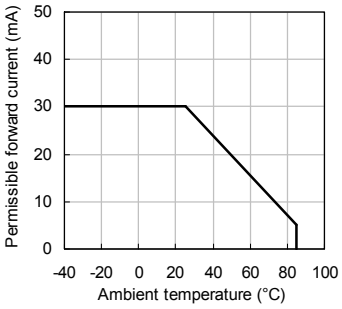
Forward Current vs. Forward Voltage



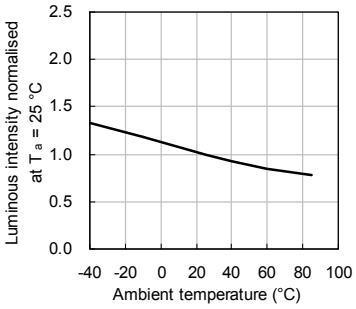
Luminous Intensity vs. Forward Current



Forward Current Derating Curve

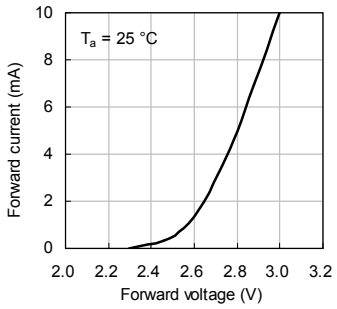


Luminous Intensity vs. Ambient Temperature

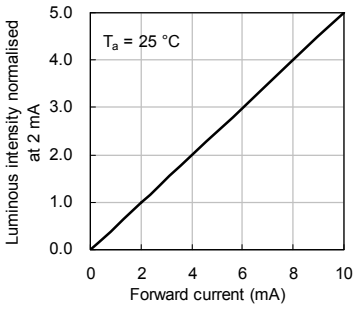


BLUE

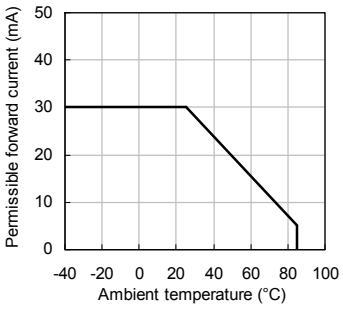
Forward Current vs. Forward Voltage



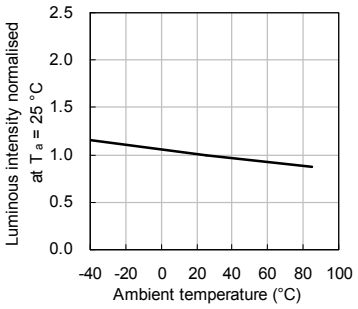
Luminous Intensity vs. Forward Current



Forward Current Derating Curve



Luminous Intensity vs. Ambient Temperature



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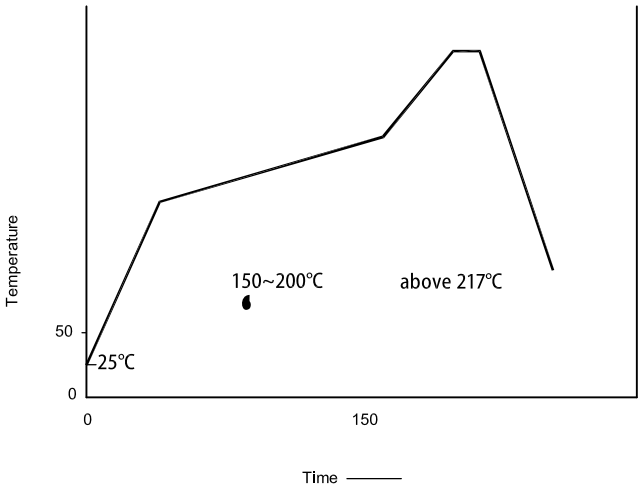
TECHNICAL DATA

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



TAPE SPECIFICATIONS (units : mm)

REEL DIMENSION (units : mm)

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